	Material Comp © Copyright 2005. I International and Par	PC, Bannockb	urn, Illinois. A	ll rights reserved untions.	nder both	This docume level parts, t	ent is a declara he declaration	ation o encor	f the substances npasses all lowe	within the r level ma	e manufactur aterials for wl	er listed i hich the n	tem. Note: nanufactur	: if the item is an as er has engineering	sembly with lowe responsibility.	
1752-21.1					Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					neous Materia	ials and Mfg Information				
Supplie	r Information															
Company	name*	Company unique ID			1	Unique ID Authority					Response Date*					
onsemi												2023-06-08				
Contact N	lame		Title - Contact			]	Phone - Contact*					Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorize	ed Representative*		Title - Representative			]	Phone - Representative*				Email - Representative*					
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date Version Manufacturing		ring Site	Weight*		UOM	Unit Type			
		LV5694P-E		Car Audio Power Supply			2023-06-08		I	РНМ			2800.0	mg	Each	
Aanufa	cturing Proccess Informa	tion		·			•									
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-		-STD-020 MSI	L Rating	Peak Pro	ocess Body Temperature Max		re Max T	Time at Peak	Temperat	ure Nun	nber of Reflow Cyc	les	
	contains Bi		CU Alloy NA			0 C		<b>30</b> seco		secon	ids 3					
Comments	3															
or more	information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	IS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead ), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl nalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temp	Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature	astislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	8.22	mg	Supplier	Silicon (Si)	7440-21-3		8.1896	mg
			Supplier	Polyimide	Proprietary Data		0.0304	mg
Die Attach	2.39	mg	Supplier	Silver (Ag)	7440-22-4		0.0717	mg
			А	Lead (Pb)	7439-92-1	7a	2.2466	mg
			Supplier	Tin (Sn)	7440-31-5		0.0478	mg
			Supplier	Copper (Cu)	7440-50-8		0.0239	mg
ead Frame	2002.18	mg	Supplier	Silver (Ag)	7440-22-4		2.0022	mg
			Supplier	Iron (Fe)	7439-89-6		1.802	mg
			Supplier	Copper (Cu)	7440-50-8		1998.1758	mg
			Supplier	Phosphorus (P)	7723-14-0		0.2001	mg
Iold Compound-Black	752.88	mg		Brominated epoxy resin	proprietary data		15.0576	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		1.5058	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		23.3393	mg
			Supplier	Carbon Black (C)	1333-86-4		2.2586	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		558.637	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		150.576	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.5058	mg
lating	33.15	mg	В	Bismuth (Bi)	7440-69-9		0.1989	mg
			Supplier	Tin (Sn)	7440-31-5		32.9511	mg
Wire Bond - Au	1.18	mg	Supplier	Gold (Au)	7440-57-5		1.18	mg